Attorney's Docket No.: 042390.P9482 PATENT

## DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION (FOR INTEL CORPORATION PATENT APPLICATIONS)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below, next to my name.

I believe I am the original, first, and sole inventor (if only one name is listed below) or an original,

first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:  Molded Flip Chip Package				
on of which				
is attached hereto. was filed on (MM/DD/YYYY)  United States Application Number or PCT International Application Number and was amended on (MM/DD/YYYY)	as 			
	is attached hereto. was filed on (MM/DD/YYYY) United States Application Number or PCT International Application Number	tent is sought on the invention entitled:  Molded Flip Chip Package  on of which  is attached hereto.  was filed on (MM/DD/YYYY)  or PCT International Application Number  and was amended on (MM/DD/YYYY)  and was amended on (MM/DD/YYYY)		

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above. I do not know and do not believe that the claimed invention was ever known or used in the United States of America before my invention thereof, or patented or described in any printed publication in any country before my invention thereof or more than one year prior to this application, that the same was not in public use or on sale in the United States of America more than one year prior to this application, and that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months (for a utility patent application) or six months (for a design patent application) prior to this application.

I acknowledge the duty to disclose all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119(a)-(d), of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s	)		Priority <u>Claimed</u>
(Number)	(Country)	(Foreign Filing Date - MM/DD/YYYY)	Yes No
(Number)	(Country)	(Foreign Filing Date - MM/DD/YYYY)	Yes No
(Number)	(Country)	(Foreign Filing Date - MM/DD/YYYY)	Yes No
I hereby claim the benefit upprovisional application(s) list	inder Title 35, United S sted below:	States Code, Section 119(e)	of any United States
Application Number	(Filing Date	- MM/DD/YYYY)	
Application-Number	(Filing Date	-MM/DD/YYYY)	
application(s) listed below a s not disclosed in the prior of Title 35, United States C known to me to be material	and, insofar as the sub United States applicat ode, Section 112, I acl to patentability as defi available between the	states Code, Section 120 of a ject matter of each of the cla ion in the manner provided b knowledge the duty to disclosined in Title 37, Code of Fed e filing date of the prior applic	ims of this application by the first paragraph se all information eral Regulations.
Application Number	(Filing Date – MM/	•	nted, ding, abandoned
Application Number	(Filing Date – MM/		ited, ding, abandoned

I hereby appoint the persons listed on Appendix A hereto (which is incorporated by reference and a part of this document) as my respective patent attorneys and patent agents, with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith.

Send correspondence to Kurt P. Leyendecker, Esq., BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP, 12400 Wilshire Boulevard 7th Floor, Los Angeles, California 90025 and direct telephone calls to Kurt P. Leyendecker, Esq., at (303) 740-1980.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Takachi Kumamoto

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